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(12) **United States Design Patent**
Ahn et al.

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(54) **HEADPHONE**
(71) Applicant: **Samsung Electronics Co., Ltd.**,
Suwon-si (KR)
(72) Inventors: **Dae-Kyung Ahn**, Namyangju-si (KR);
Dae-Joung Kim, Seoul (KR);
Sang-Sung Woo, Seoul (KR); **Hong-Pyo**
Kim, Seoul (KR); **Chi-Young Ahn**,
Seoul (KR)
(73) Assignee: **Samsung Electronics Co., Ltd.**,
Suwon-si (KR)
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(Continued)

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(52) **U.S. Cl.**
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See application file for complete search history.

Primary Examiner — Paula Greene
(74) *Attorney, Agent, or Firm* — NSIP Law

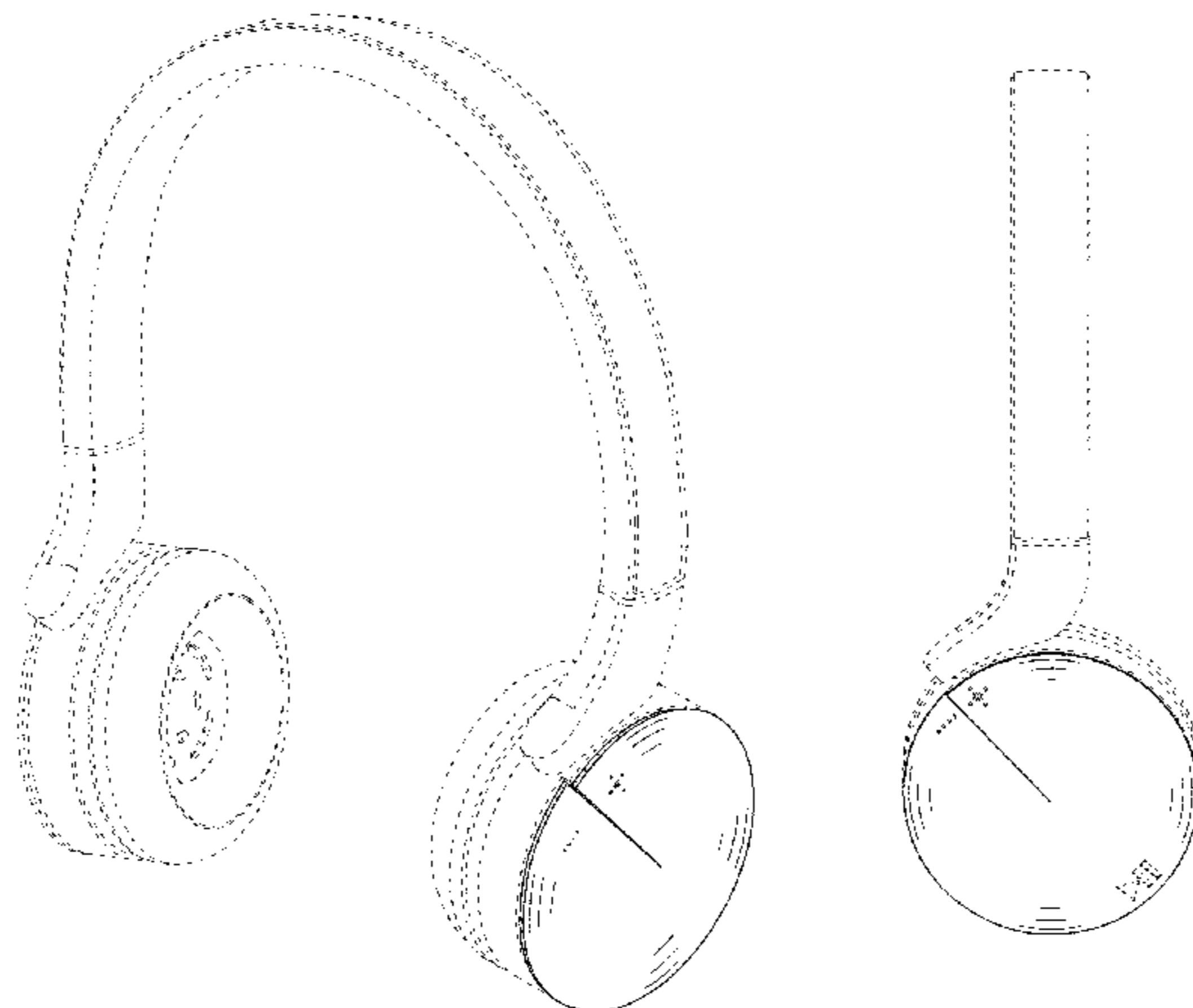
(57) **CLAIM**
We claim the ornamental design for a headphone, as shown
and described.

DESCRIPTION

FIG. 1 is a front perspective view of a headphone showing our
new design;
FIG. 2 is a front view thereof;
FIG. 3 is a rear view thereof;
FIG. 4 is a left-side view thereof;
FIG. 5 is a right side view thereof, the interior surface of the
right earphone cap of the headphone is not shown in the
drawing or described in the specification;
FIG. 6 is a top view thereof;
FIG. 7 is a bottom view thereof; and,
FIG. 8 is an enlarged view of the encircled portion in FIG. 2.
The broken lines in the figures show portions of the head-
phone which form no part of the claimed design.
The dot-dash broken lines encircling portions of the claimed
design that are illustrated in enlargements form no part of the
claimed design.

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1 Claim, 8 Drawing Sheets



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FIG. 1

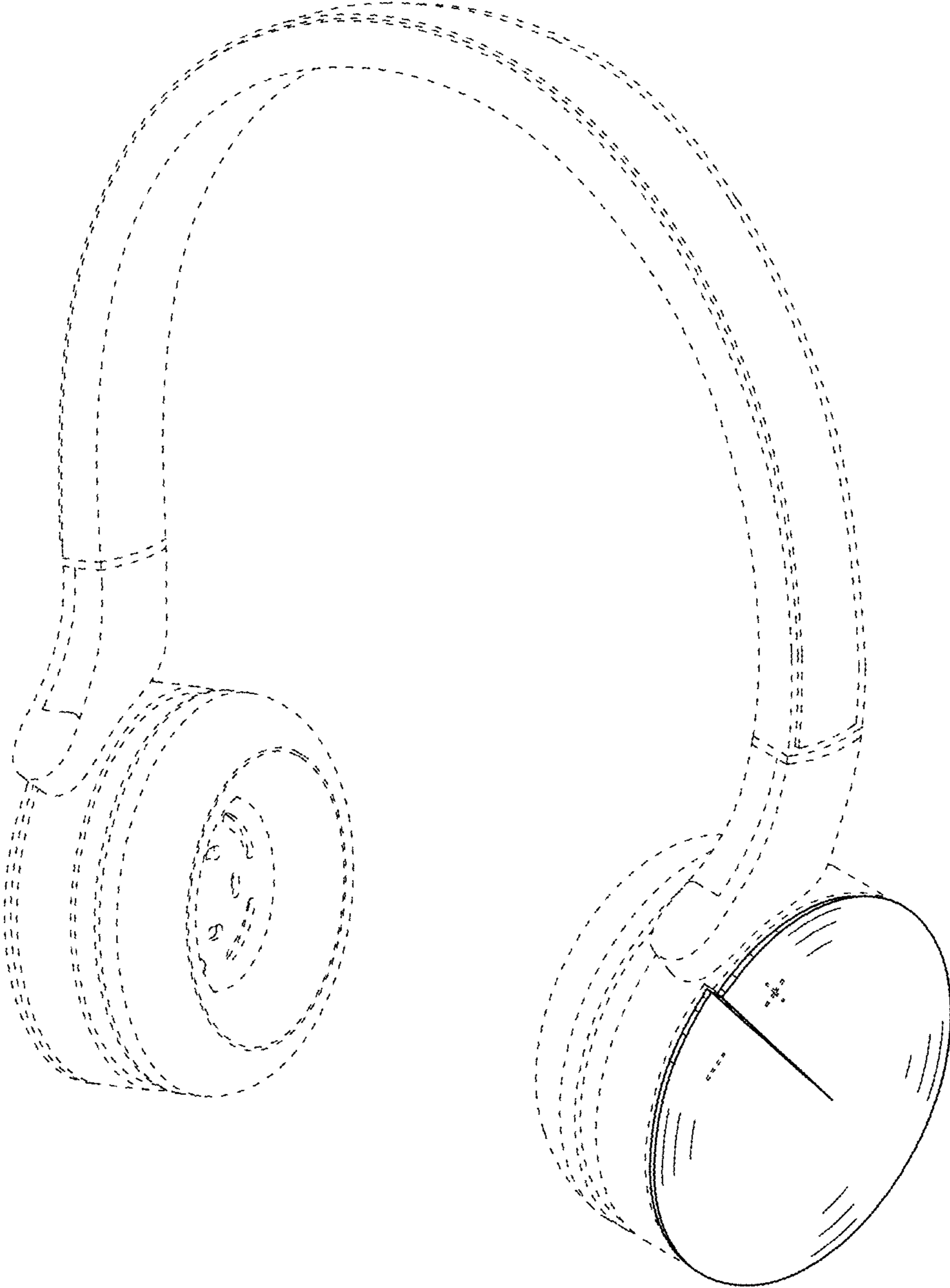


FIG. 2

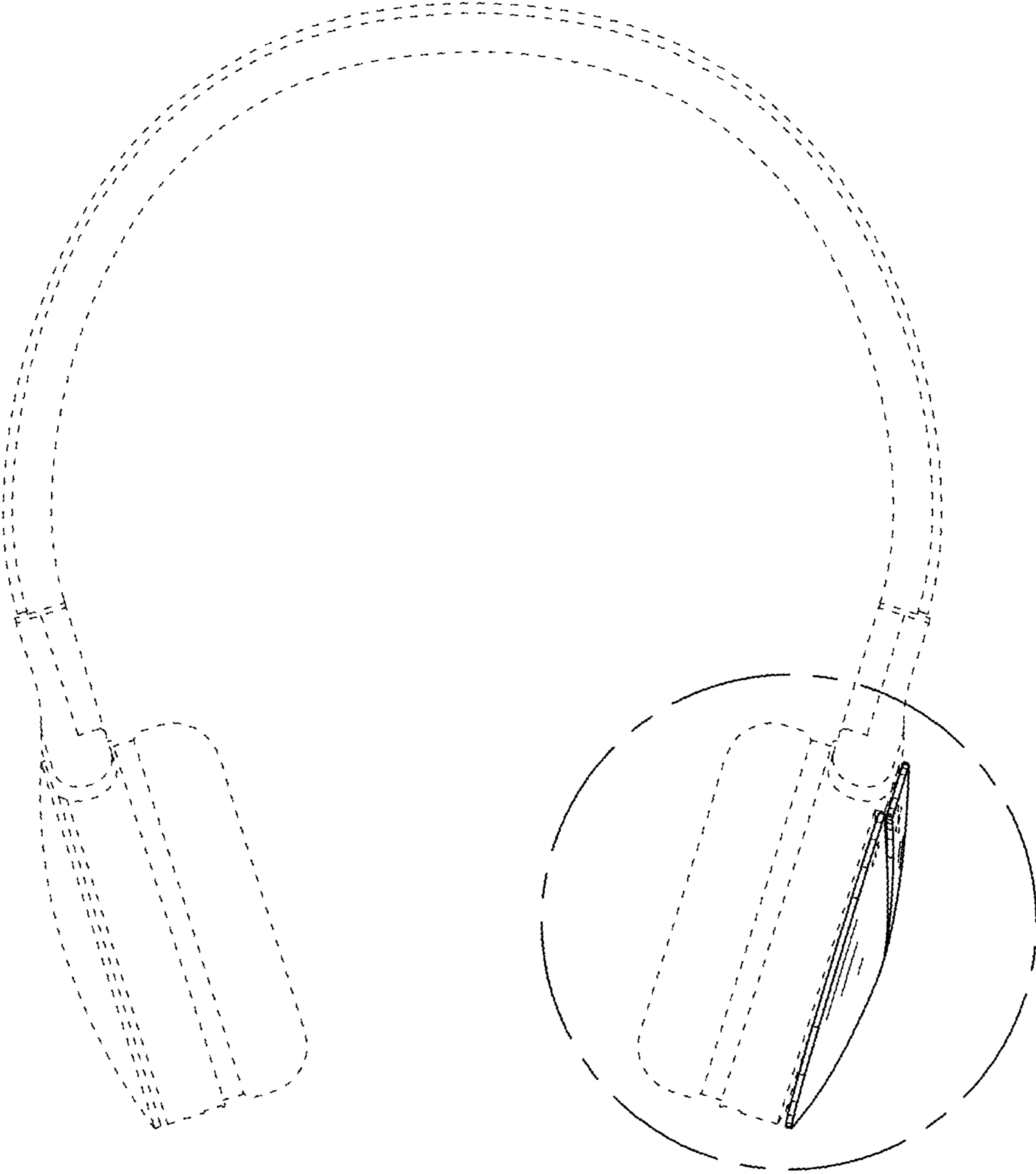


FIG. 3

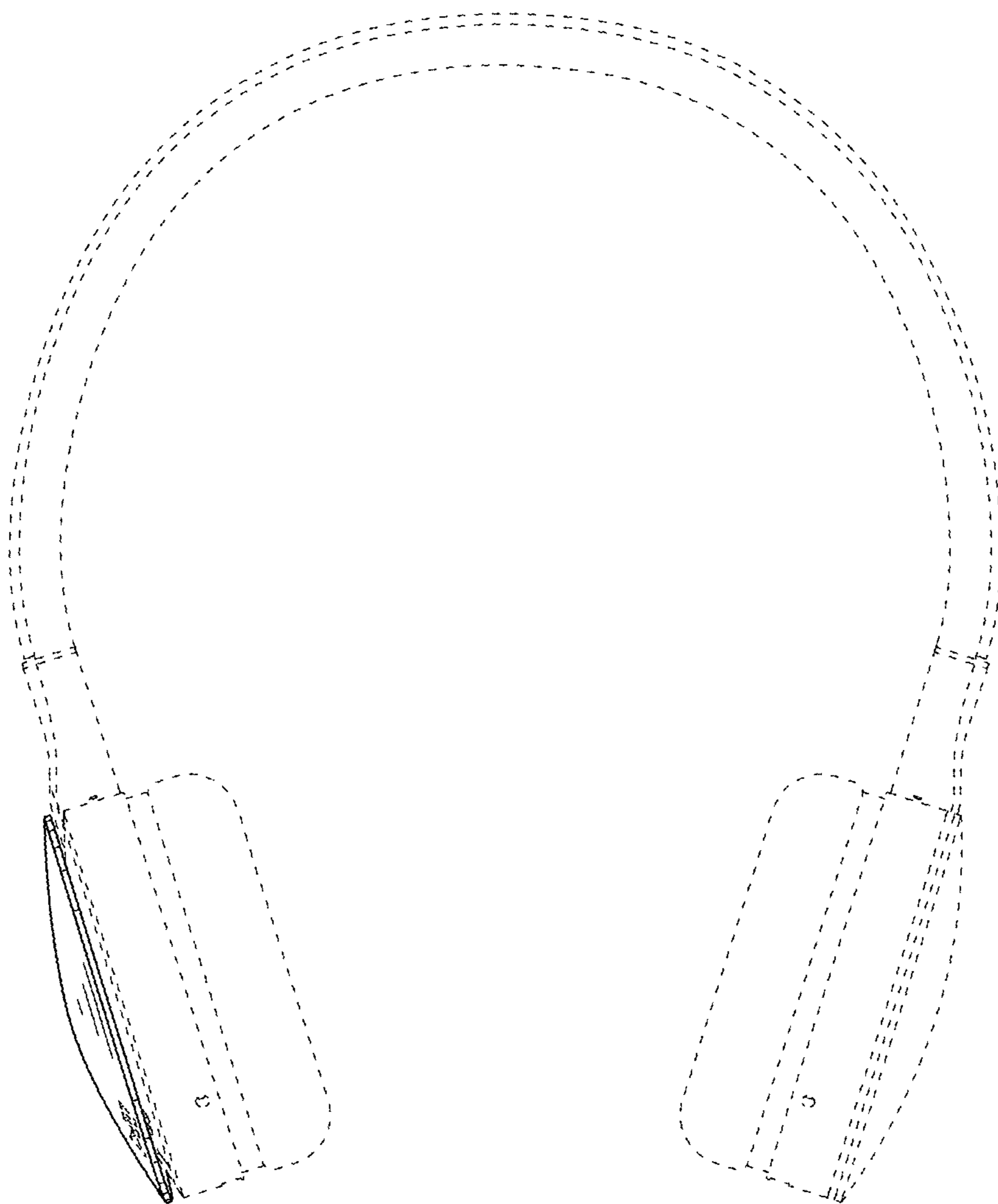


FIG. 4

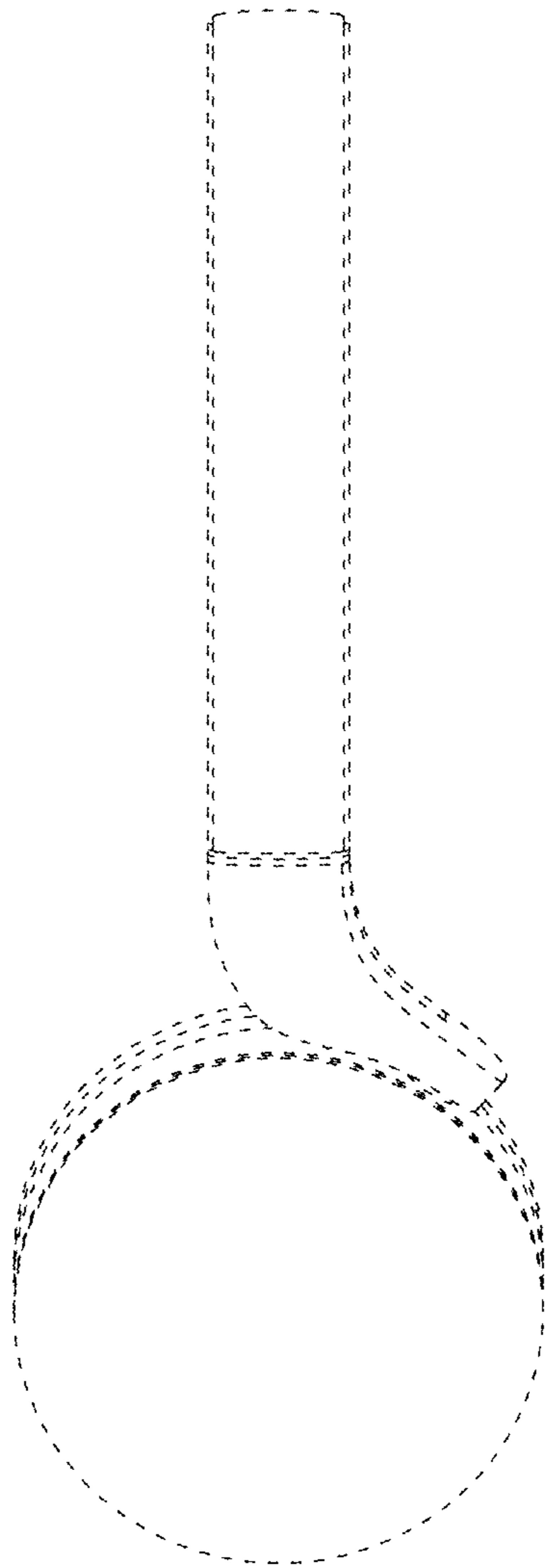


FIG. 5

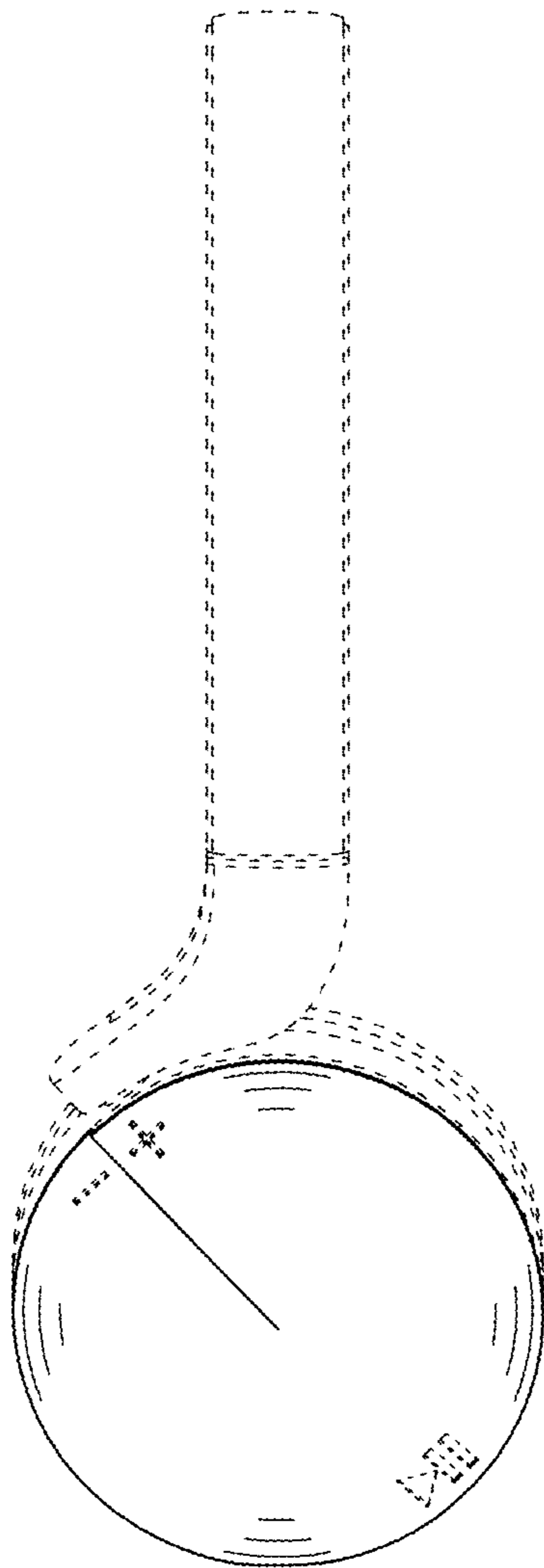


FIG. 6

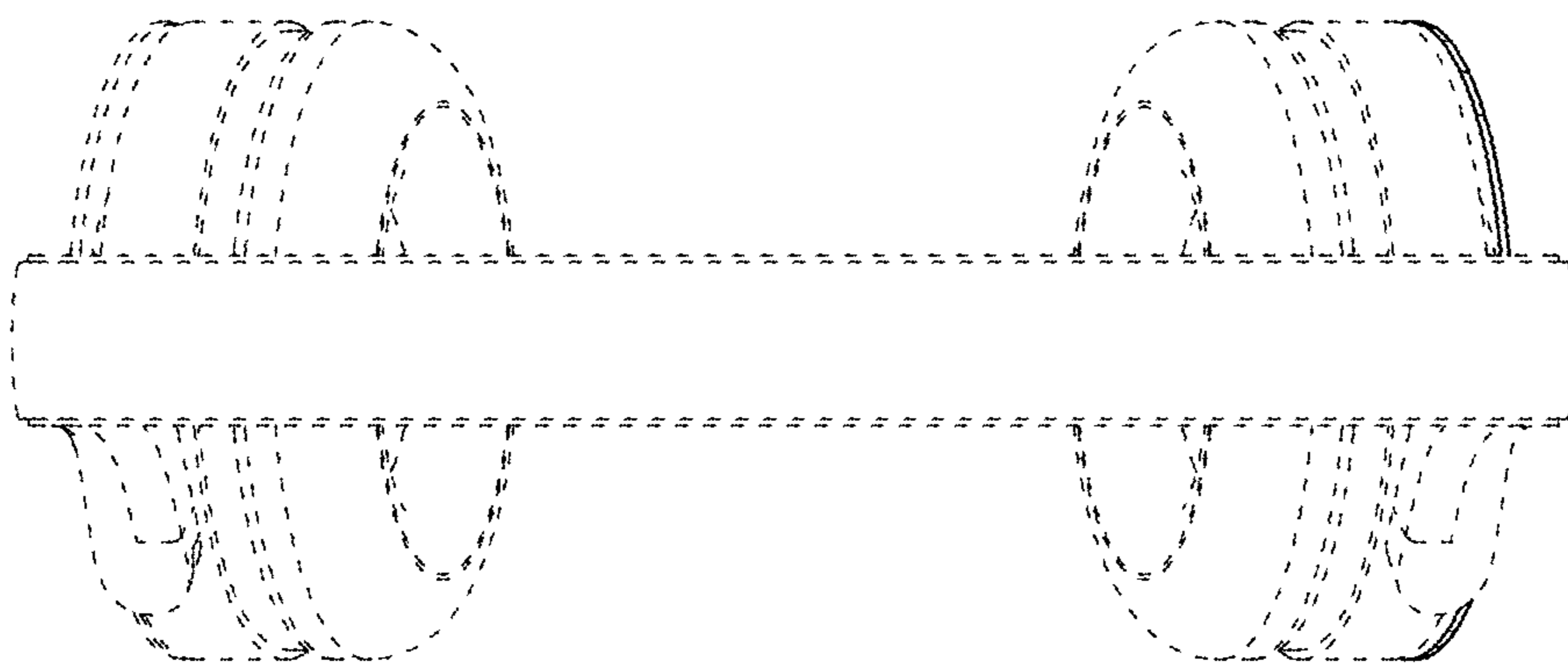


FIG. 7

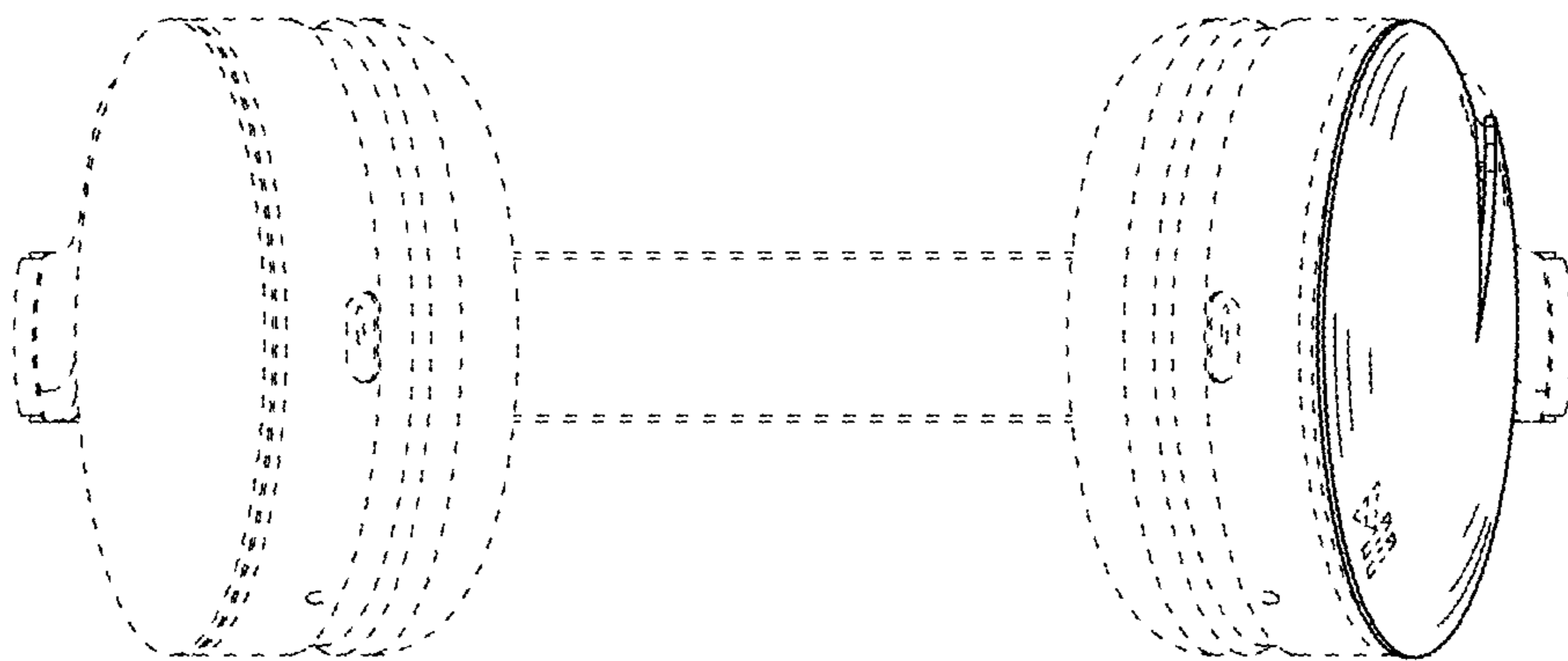


FIG. 8

